

Inventors: Reed, Ke, Godzik
Serial No.: 10/071,174
Filed: February 7, 2002
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DECLARATION FOR PATENT APPLICATION

As the below-named inventor(s), we hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe that I am an original, first inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled APOPTOSIS MODULATOR BCL-B AND METHODS FOR MAKING AND USING SAME, the specification of which was filed on February 7, 2002 as Application-Serial Number 10/071,174, Attorney Docket No. 087102-027 2558.

I hereby state that I have reviewed and understand the contents of the above identified application, including the claims, as amended by any amendment(s) referred to above.

I acknowledge the duty to disclose to the U.S. Patent and Trademark Office all information known to myself to be material to patentability as defined in Title 37, Code of Federal Regulations, Sec. 1.56.

Under Sec. 1.56, information is material to patentability when it is not cumulative to information already of record or being made of record in the application, and (1) It establishes, by itself or in combination with other information a prima facie case of unpatentability of a claim; or (2) It refutes, or is inconsistent with, a position the applicant takes in: (a) Opposing an argument of unpatentability relied on by the U.S. Patent and Trademark Office, or (b) Asserting an argument of patentability.

I hereby claim the benefit under Title 35, United States Code §119(e) of the United States provisional application(s) listed below, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application(s) in the manner provided by the first paragraph of Title 35, United States Code §112, I acknowledge the duty to disclose information

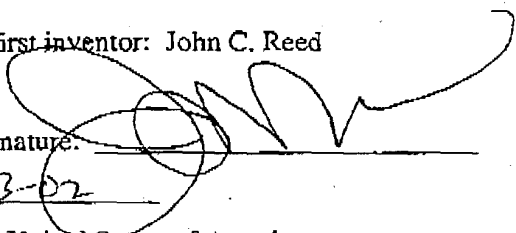
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that is material to patentability as defined in Title 37, Code of Federal Regulations §1.56 that became available between the filing date of the prior application(s) listed below and the filing date of this non-provisional application:

<u>Application Serial No.</u>	<u>Filing Date</u>	<u>Status</u>
60/267,166	February 7, 2001	Abandoned

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18, United States Code §1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of first inventor: John C. Reed

Inventor's Signature: 

Date: 6-13-02

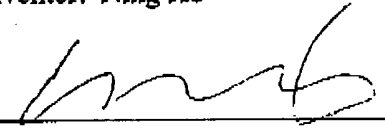
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Inventor's Signature: *Adam Godzik*

Date: 6/20/2002

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